Old Company Name in Catalogs and Other Documents

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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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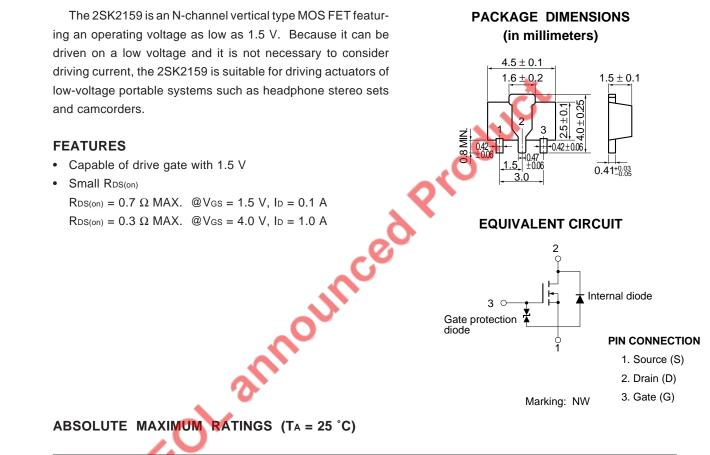
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RENESAS

MOS FIELD EFFECT TRANSISTOR 2SK2159

N-CHANNEL MOS FET FOR HIGH-SPEED SWITCHING



PARAMETER	SYMBOL	TEST CONDITIONS	RATINGS	UNIT
Drain to Source Voltage	Vdss	V _{GS} = 0	60	V
Gate to Source Voltage	Vgss	V _{DS} = 0	±14	V
Drain Current (DC)	ID(DC)		±2.0	A
Drain Current (pulse)	D(pulse)	PW ≤ 10 ms, Duty Cycle ≤ 50 %	±4.0	A
Total Power Dissipation	P⊤	Mounted on 16 $\mbox{cm}^2 \times 0.7$ mm ceramic substrate.	2.0	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Document No. D11235EJ2V0DS00 (2nd edition) Date Published June 1996 P Printed in Japan

ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C)

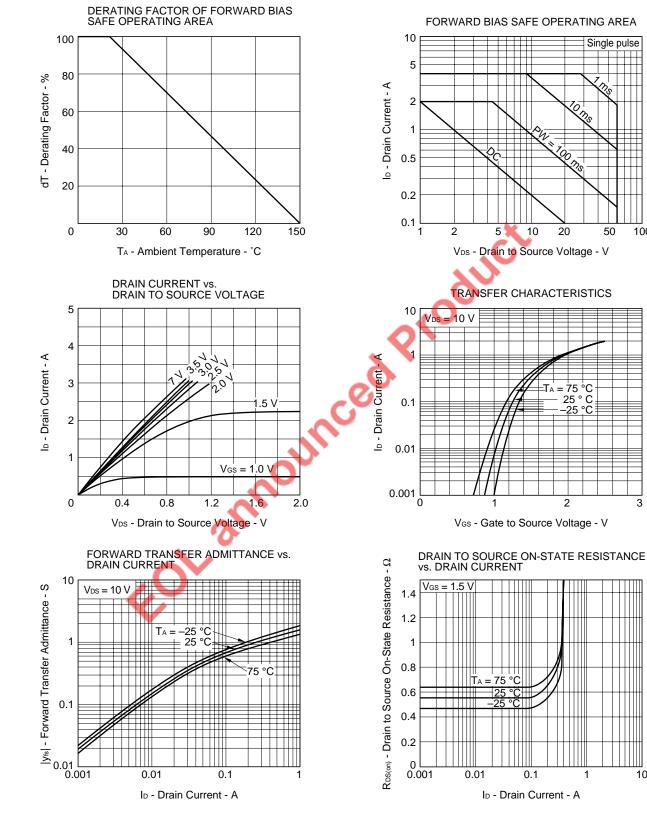
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-off Current	loss	$V_{DS} = 60 V, V_{GS} = 0$			1.0	μΑ
Gate Leakage Current	lgss	$V_{GS} = \pm 14 \text{ V}, \text{ V}_{DS} = 0$			±10	μA
Gate Cut-off Voltage	VGS(off)	$V_{DS} = 10 V, I_{D} = 1 mA$	0.5	0.9	1.1	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 1.0 A	0.4			S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 1.5 V, Id = 0.1 A		0.55	0.7	Ω
Drain to Source On-state Resistance	RDS(on)2	Vgs = 2.5 V, Id = 1.0 A		0.27	0.5	Ω
Drain to Source On-state Resistance	RDS(on)3	Vgs = 4.0 V, Id = 1.0 A		0.22	0.3	Ω
Input Capacitance	Ciss	$V_{DS} = 10 V, V_{GS} = 0,$		319		pF
Output Capacitance	Coss	f = 1.0 MHz		109		pF
Reverse Transfer Capacitance	Crss			22		pF
Turn-On Delay Time	td(on)	V _{DD} = 25 V, I _D = 1.0 A		38		ns
Rise Time	tr	$V_{GS(on)} = 3 V, R_G = 10 \Omega$		128		ns
Turn-Off Delay Time	td(off)	RL = 25 Ω	0	237		ns
Fall Time	tŕ		0	130		ns

100

3

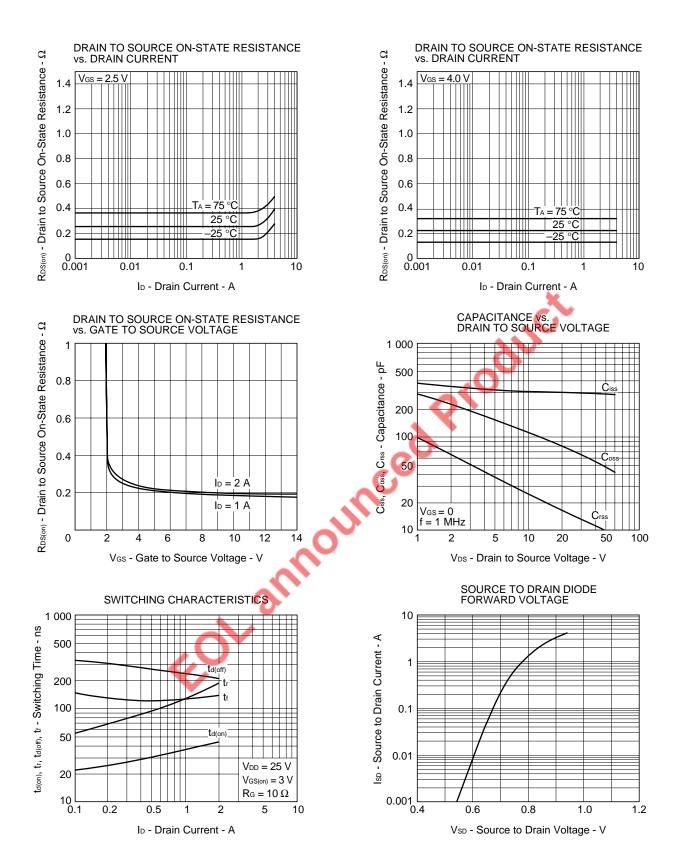
dT - Derating Factor - %

Ip - Drain Current - A



TYPICAL CHARACTERISTICS ($T_A = 25$ °C)

10



REFERENCE

Document Name	Document No.		
NEC semiconductor device reliability/quality control system	TEI-1202		
Quality grade on NEC semiconductor devices	IEI-1209		
Semiconductor device mounting technology manual	C10535E		
Guide to quality assurance for semiconductor devices	MEI-1202		
Semiconductor selection guide	X10679E		

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NEC devices are classified into the following three quality grades:

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Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices in "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact NEC Sales Representative in advance.

Anti-radioactive design is not implemented in this product.

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